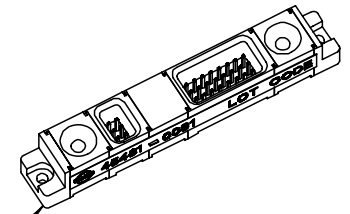


NOTES:

1. MATERIAL: LCP, GLASS FILLED, UL94V-0, BLACK.
CONTACTS: COPPER ALLOY
2. FINISH: SELECT GOLD: 30 MI MIN.
SELECT TIN: 100 MI MIN.
BOTH OVER NICKEL.
3. PRODUCT SPECIFICATION: PS-45424-001.
4. PACKAGING SPECIFICATION: PK-45481-001.



MODULE 1

PD 500	PD 502	PD 312	PD 513	PD 300	PD 502	PD 501
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PCB LAYOUT: COMPONENT SIDE
PCB THICKNESS: .125/3.18
PCB TOLERANCE: ±.002/0.05

EC NO: UCP2006-0519	DRWN: ADRA TNL2005/09/12	CHKD: 2005/09/15	APPR: APATEL 2005/09/15
DESCRIPTION			
REV			

QUALITY SYMBOLS

GENERAL TOLERANCES (UNLESS SPECIFIED)	mm	INCH
	4 PLACES ± ---	± ---
	3 PLACES ± ---	± .010
	2 PLACES ± 0.25	± .015
	1 PLACE ± 0.38	± ---
	ANGULAR ± 1/2°	
DRAFT WHERE APPLICABLE		
MUST REMAIN WITHIN DIMENSIONS		

SCALE	DESIGN UNITS
1:1.25	METRIC
DIMENSION STYLE	
IN/MM	
DRAWN BY	DATE
SCHAFFER	2004/04/01
CHECKED BY	DATE
SAMIEC	2004/04/01
APPROVED BY	DATE
MARGULIS	2004/04/01

THIRD ANGLE PROJECTION	REVISE ON CAD ONLY
TITLE	
POWER DOCK ASSEMBLY POWER VERTICAL SOLDER TAIL	
molex MOLEX INCORPORATED	
MATERIAL NO.	DOCUMENT NO.
45481-0091	SD-45481-091
SHEET NO.	1 OF 1

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